



# ES8374

## Low Power Mono Audio CODEC

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### FEATURES

#### System

- High performance and low power multi-bit delta-sigma audio ADC and DAC
- I<sup>2</sup>S/PCM master or slave serial data port
- Two pairs of analog input with differential input option
- Mono analog output
- 256/384Fs, USB 12/24 MHz, fractional PLL for wide range of system clocks
- Standard audio clock output
- Sophisticated analog input and output routing, mixing and gain
- GPIO
- I<sup>2</sup>C interface

#### ADC

- 24-bit, 8 to 96 kHz sampling frequency
- 95 dB signal to noise ratio, -85 dB THD+N
- Low noise pre-amplifier
- Noise reduction filters
- Auto level control (ALC) and noise gate
- Support analog and digital microphone
- Microphone bias

#### DAC

- 24-bit, 8 to 96 kHz sampling frequency
- 95 dB signal to noise ratio, -85 dB THD+N
- 1.25W@8Ω/5V or 1.8W@4Ω/4.2V mono class D speaker driver
- Dynamic range compression
- Headphone and external mic detection
- Pop and click noise suppression

#### Low Power

- 3.3V to 5V operation
- 32 mW playback; 42 mW playback and record
- Low standby current

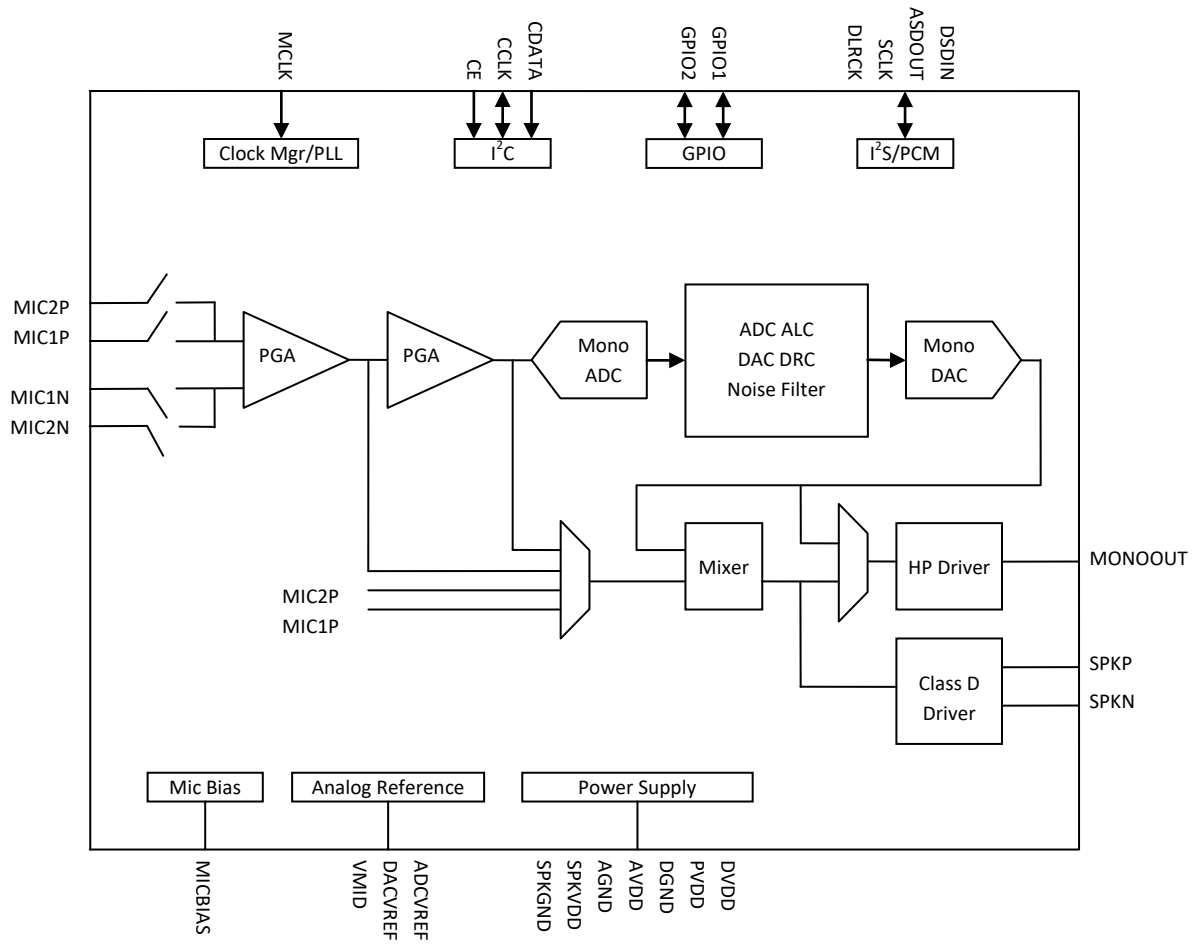
### APPLICATIONS

- Car DV
- IP Camera
- DVR, NVR
- Surveillance

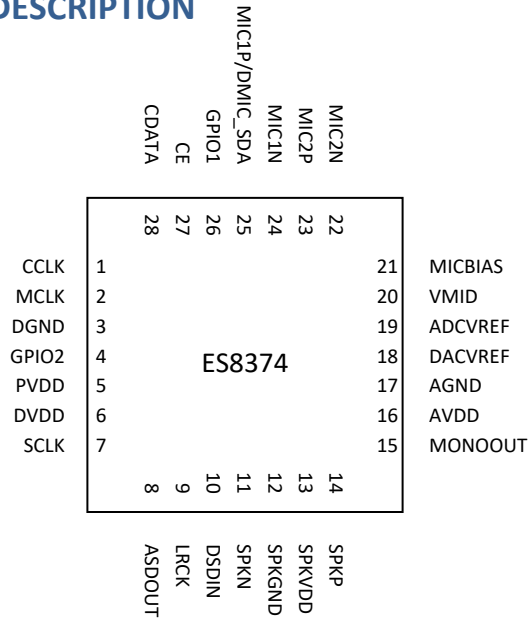
### ORDERING INFORMATION

ES8374 -40°C ~ +85°C  
QFN-28

### 1. BLOCK DIAGRAM

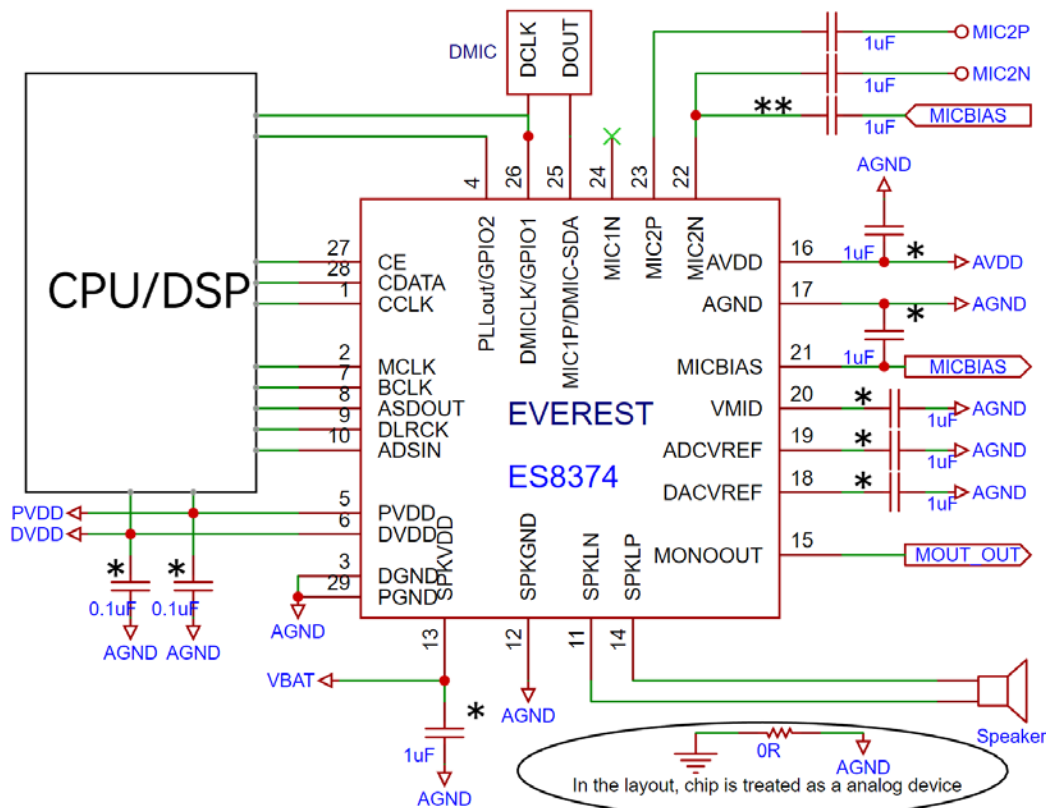


## 2. PIN OUT AND DESCRIPTION



NAME	I/O	DESCRIPTION
MCLK	DI	Master clock
CDATA	DIO	I <sup>2</sup> C data
CCLK	DI	I <sup>2</sup> C clock
CE	DI	I <sup>2</sup> C address
GPIO1	DIO	GPIO (digital mic clock, jack detect, PLL out, interrupt)
GPIO2	DIO	GPIO (PLL out, interrupt)
ASDOUT	DO	I <sup>2</sup> S/PCM serial data out
DSDIN	DI	I <sup>2</sup> S/PCM serial data in
LRCK	DIO	I <sup>2</sup> S/PCM left and right clock
SCLK	DIO	I <sup>2</sup> S/PCM bit clock
MIC1P/DMIC_SDA	AI	P analog input or digital mic data
MIC1N	AI	N analog input
MIC2P	AI	P analog input
MIC2N	AI	N analog input
MONOOUT	AO	Mono output
SPKP	AO	Positive speaker out
SPKN	AO	Negative speaker out
MICBIAS		Mic bias
ADCVRP		ADC reference filtering
DACVRP		DAC reference filtering
VMID		Common mode filtering
DVDD		Digital core power supply
PVDD		Digital IO power supply
DGND		Digital ground
AVDD		Analog power supply
AGND		Analog ground
SPKVDD		Speaker driver power supply
SPKGND		Speaker driver ground

### 3. TYPICAL APPLICATION CIRCUIT



- \* For the best performance, decoupling and filtering capacitors should be located as close to the device package as possible
- \*\* To balance the power supply of Micbias in MIC application circuits

### 4. CLOCK MODES AND SAMPLING FREQUENCIES

The device supports three types of clocking: standard audio clocks (256Fs, 384Fs, 512Fs, etc), USB clocks (12/24 MHz), and an on-chip 22-bit fractional PLL clock (minimal PLL input is 2 MHz).

According to the serial audio data sampling frequency (Fs), the device can work in two speed modes: single speed mode or double speed mode. In single speed mode, Fs normally ranges from 8 kHz to 48 kHz, and in double speed mode, Fs normally range from 64 kHz to 96 kHz.

The device can work either in master clock mode or slave clock mode. In slave mode, LRCK and SCLK are supplied externally, and LRCK and SCLK must be synchronously derived from the system clock with specific rates. In master mode, LRCK and SCLK are derived internally from device master clock.

### 5. MICRO-CONTROLLER CONFIGURATION INTERFACE

The device supports standard I<sup>2</sup>C micro-controller configuration interface. External micro-controller can completely configure the device through writing to internal configuration registers.

I<sup>2</sup>C interface is a bi-directional serial bus that uses a serial data line (SDA) and a serial clock line (SCL) for data transfer. The timing diagram for data transfer of this interface is given in Figure 1. Data are transmitted synchronously to SCL clock on the SDA line on a byte-by-byte basis. Each bit in a byte is sampled during SCL high with MSB bit being transmitted firstly. Each transferred byte is followed by an acknowledge bit from receiver to pull the SDA low. The transfer rate of this interface can be up to 400 kbps.

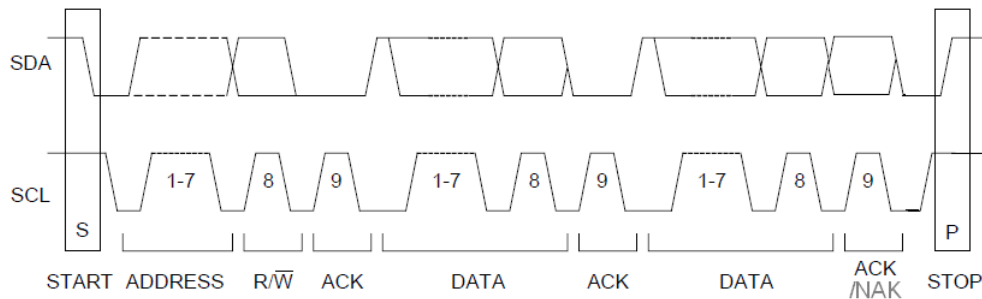


Figure 1 Data Transfer for I<sup>2</sup>C Interface

A master controller initiates the transmission by sending a “start” signal, which is defined as a high-to-low transition at SDA while SCL is high. The first byte transferred is the slave address. It is a seven-bit chip address followed by a RW bit. The chip address must be 001000x, where x equals ADO. The RW bit indicates the slave data transfer direction. Once an acknowledge bit is received, the data transfer starts to proceed on a byte-by-byte basis in the direction specified by the RW bit. The master can terminate the communication by generating a “stop” signal, which is defined as a low-to-high transition at SDA while SCL is high.

In I<sup>2</sup>C interface mode, the registers can be written and read. The formats of “write” and “read” instructions are shown in Table 1 and Table 2. Please note that, to read data from a register, you must set R/W bit to 0 to access the register address and then set R/W to 1 to read data from the register.

Table 1 Write Data to Register in I<sup>2</sup>C Interface Mode

Chip Address	R/W		Register Address		Data to be written
001000	AD0	0	ACK	RAM	ACK
					DATA

Table 2 Read Data from Register in I<sup>2</sup>C Interface Mode

Chip Address	R/W		Register Address
001000	AD0	0	ACK
			RAM
Chip Address	R/W		Data to be read
001000	AD0	1	ACK
			Data

## 6. DIGITAL AUDIO INTERFACE

The device provides many formats of serial audio data interface to the input of the DAC or output from the ADC through LRCK, BCLK (SCLK) and DACDAT/ADCDAT pins. These formats are I<sup>2</sup>S, left justified, right justified, DSP/PCM and TDM mode. DAC input DACDAT is sampled by the device on the rising edge of SCLK. ADC data is out at ADCDAT on the falling edge of SCLK. The relationship of SDATA (DACDAT/ADCDAT), SCLK and LRCK with these formats are shown through Figure 2 to Figure 6.

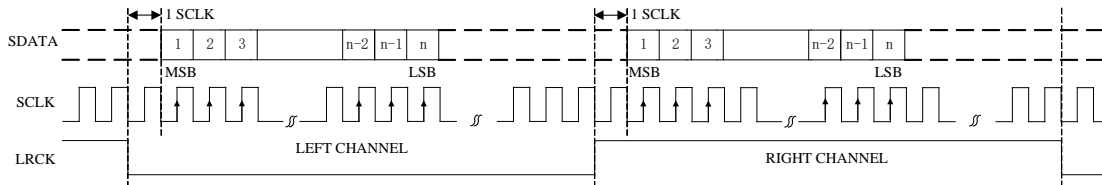


Figure 2 I<sup>2</sup>S Serial Audio Data Format Up To 24-bit

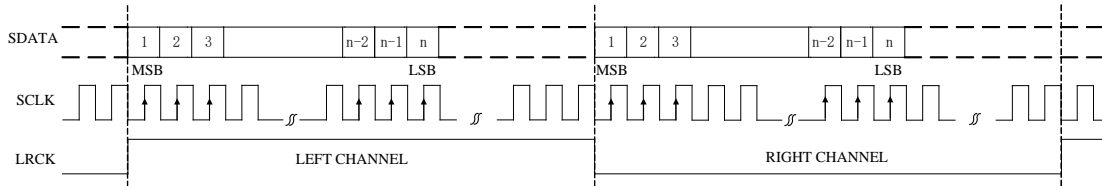


Figure 3 Left Justified Serial Audio Data Format Up To 24-bit

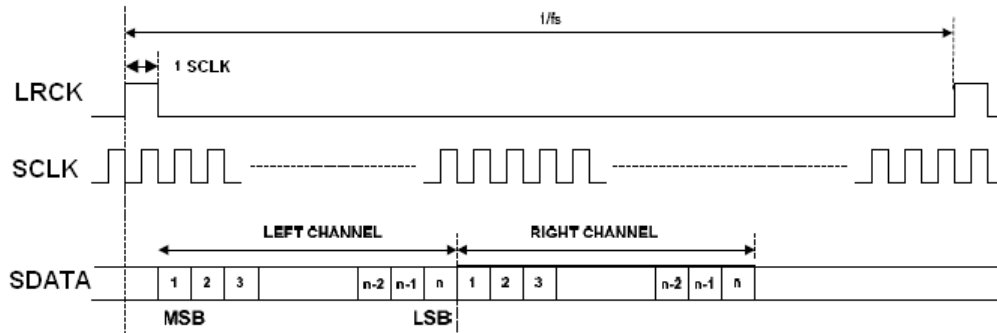


Figure 4 DSP/PCM Mode A

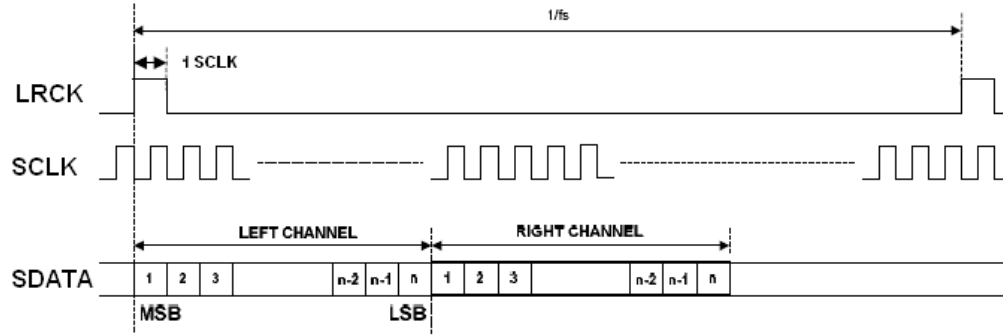


Figure 5 DSP/PCM Mode B

## 7. ELECTRICAL CHARACTERISTICS

### ABSOLUTE MAXIMUM RATINGS

Continuous operation at or beyond these conditions may permanently damage the device.

PARAMETER	MIN	MAX
Analog Supply Voltage Level	-0.3V	+5.5V
Digital Supply Voltage Level	-0.3V	+5.5V
Analog Input Voltage Range	AGND-0.3V	AVDD+0.3V
Digital Input Voltage Range	DGND-0.3V	PVDD+0.3V
Operating Temperature Range	-40°C	+85°C
Storage Temperature	-65°C	+150°C

### RECOMMENDED OPERATING CONDITIONS

PARAMETER	MIN	TYP	MAX	UNIT
AVDD	3	3.3/5	5.5	V
SPKVDD (Note 1, 2)				V
4Ω Speaker	3	3.3/4.2	5	
8Ω Speaker	3	3.3/5	5.5	
DVDD	3	3.3/5	5.5	V
PVDD (DVDD - input high level < 2V)	1.6	1.8/3.3/5	5.5	V

Note 1: package thermal pad must be connected to ground as much as possible to provide class D speaker driver heat dissipation.

Note 2: when standby class D speaker driver, with all power supply on, entering low power through control register setting, then stopping MCLK.

**ADC ANALOG AND FILTER CHARACTERISTICS AND SPECIFICATIONS**

Test conditions are as the following unless otherwise specify: AVDD=3.3V, DVDD=3.3V, AGND=0V, DGND=0V, Ambient temperature=25°C, Fs=48 KHz or 96 KHz, MCLK/LRCK=256.

PARAMETER	MIN	TYP	MAX	UNIT
ADC Performance				
Signal to Noise ratio (A-weight)	85	95	98	dB
THD+N	-88	-85	-75	dB
Gain Error			±5	%
Filter Frequency Response – Single Speed				
Passband	0		0.4535	Fs
Stopband	0.5465			Fs
Passband Ripple			±0.05	dB
Stopband Attenuation	50			dB
Filter Frequency Response – Double Speed				
Passband	0		0.2268	Fs
Stopband	0.4535			Fs
Passband Ripple			±0.005	dB
Stopband Attenuation	50			dB
Analog Input				
Full Scale Input (differential P and N)		AVDD/3.3		Vrms
Input Impedance		10		KΩ

**DAC ANALOG AND FILTER CHARACTERISTICS AND SPECIFICATIONS**

Test conditions are as the following unless otherwise specify: AVDD=3.3V, DVDD=3.3V, AGND=0V, DGND=0V, Ambient temperature=25°C, Fs=48 KHz or 96 KHz, MCLK/LRCK=256.

PARAMETER	MIN	TYP	MAX	UNIT
DAC Performance				
Signal to Noise ratio (A-weight)	83	95	98	dB
THD+N	-88	-85	-75	dB
Filter Frequency Response – Single Speed				
Passband	0		0.4535	Fs
Stopband	0.5465			Fs
Passband Ripple			±0.05	dB
Stopband Attenuation	53			dB
Filter Frequency Response – Double Speed				
Passband	0		0.4167	Fs
Stopband	0.7917			Fs
Passband Ripple			±0.005	dB
Stopband Attenuation	56			dB
Analog Output				
Full Scale Output Level		AVDD/3.3		Vrms



**DC CHARACTERISTICS**

PARAMETER	MIN	TYP	MAX	UNIT
Normal Operation Mode				
DVDD=3.3V, PVDD=3.3V, AVDD=3.3V:				mW
Play back		32		
Play back and record		42		
Power Down Mode				
DVDD=3.3V, PVDD=3.3V, AVDD=3.3V		50		uA
Digital Voltage Level				
Input High-level Voltage	0.7*PVDD			V
Input Low-level Voltage			0.5	V
Output High-level Voltage		PVDD		V
Output Low-level Voltage		0		V

**SERIAL AUDIO PORT SWITCHING SPECIFICATIONS**

PARAMETER	Symbol	MIN	MAX	UNIT
MCLK frequency			51.2	MHz
MCLK duty cycle		40	60	%
LRCK frequency			200	KHz
LRCK duty cycle		40	60	%
SCLK frequency			26	MHz
SCLK pulse width low	TSCLKL	15		ns
SCLK Pulse width high	TSCLKH	15		ns
SCLK falling to LRCK edge	TSLR	-10	10	ns
SCLK falling to SDOUT valid	TSDO	0		ns
SDIN valid to SCLK rising setup time	TSDIS	10		ns
SCLK rising to SDIN hold time	TSDIH	10		ns

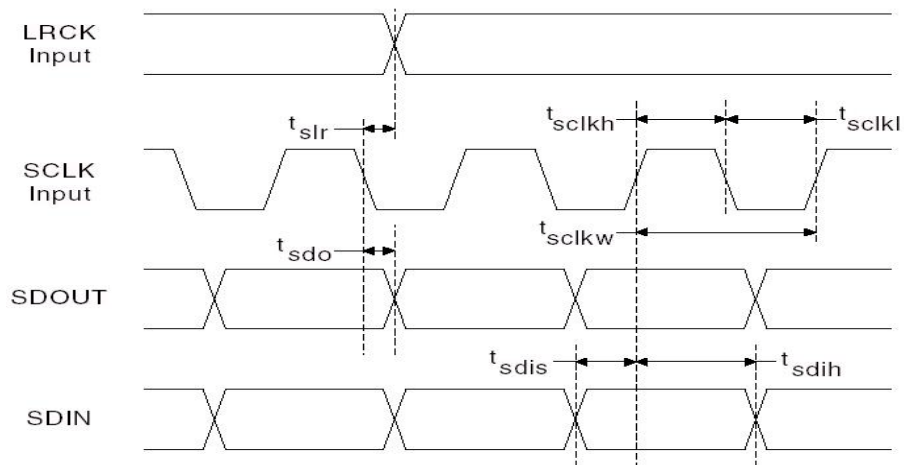
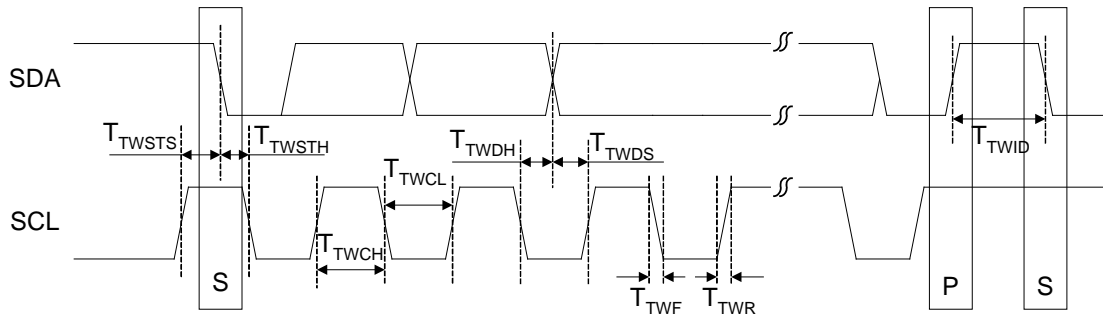


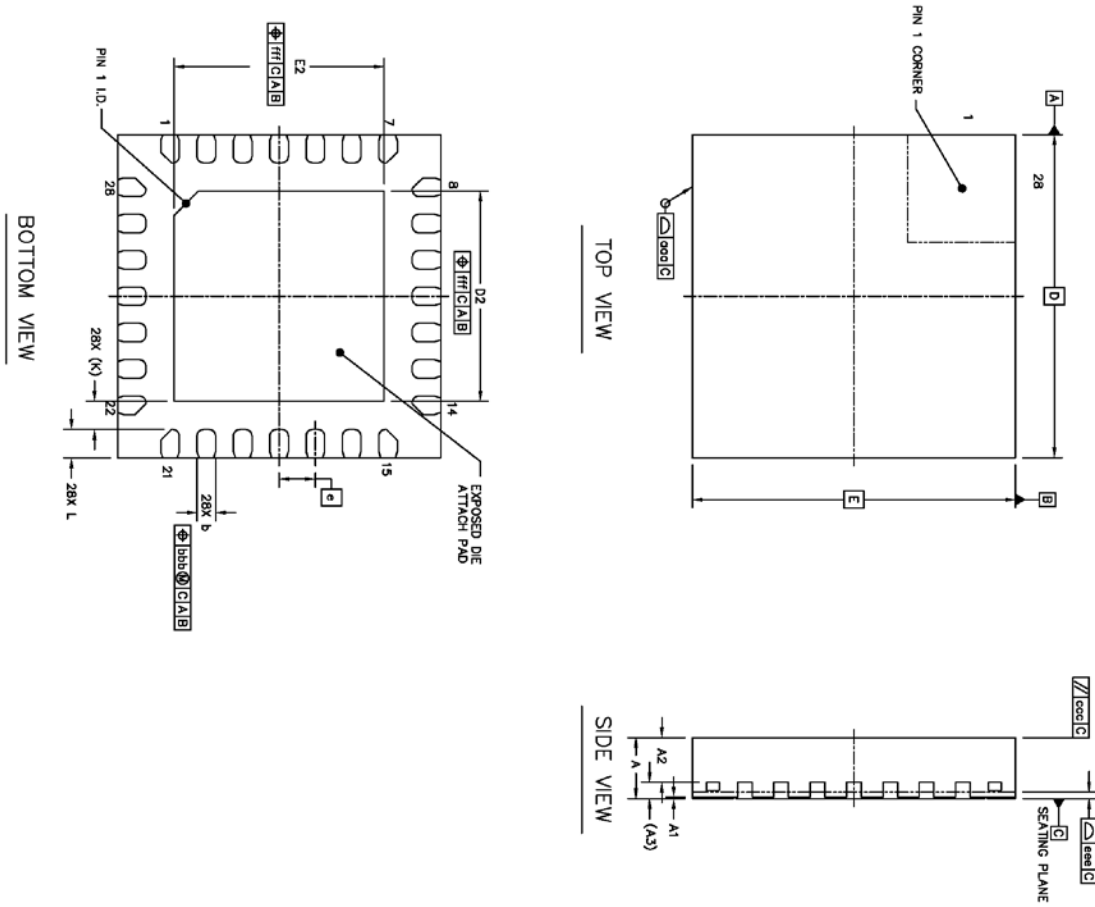
Figure 6 Serial Audio Port Timing

**I<sup>2</sup>C SWITCHING SPECIFICATIONS (SLOW SPEED MODE/HIGH SPEED MODE)**

PARAMETER	Symbol	MIN	MAX	UNIT
CCLK Clock Frequency	F <sub>CCLK</sub>		100/400	KHz
Bus Free Time Between Transmissions	T <sub>TWID</sub>	4.7/1.3		us
Start Condition Hold Time	T <sub>TWSTH</sub>	4.0/0.6		us
Clock Low time	T <sub>TWCL</sub>	4.7/1.3		us
Clock High Time	T <sub>TWCH</sub>	4.0/0.6		us
Setup Time for Repeated Start Condition	T <sub>TWSTS</sub>	4.7/0.6		us
CDATA Hold Time from CCLK Falling	T <sub>TWDH</sub>		3.45/0.9	us
CDATA Setup time to CCLK Rising	T <sub>TWDS</sub>	0.25/0.1		us
Rise Time of CCLK	T <sub>TWR</sub>		1.0/0.3	us
Fall Time CCLK	T <sub>TWF</sub>		1.0/0.3	us

Figure 7 I<sup>2</sup>C Timing

### 8. PACKAGE (UNIT: MM)



	SYMBOL	MIN	NOM	MAX
TOTAL THICKNESS	A	0.7	0.75	0.8
STAND OFF	A1	0	0.02	0.05
MOLD THICKNESS	A2	---	0.55	---
L/F THICKNESS	A3	0.203 REF		
LEAD WIDTH	b	0.18	0.23	0.28
BODY SIZE	D	4 BSC		
	E	4 BSC		
LEAD PITCH	e	0.45 BSC		
EP SIZE	D2	2.5	2.6	2.7
	E2	2.5	2.6	2.7
LEAD LENGTH	L	0.25	0.35	0.45
LEAD TIP TO EXPOSED PAD EDGE	K	0.35 REF		
PACKAGE EDGE TOLERANCE	ooo	0.1		
MOLD FLATNESS	ccc	0.1		
COPLANARITY	eee	0.08		
LEAD OFFSET	bbb	0.1		
EXPOSED PAD OFFSET	fff	0.1		

## 9. CORPORATE INFORMATION

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